

FERD technology outperforms Schottky diodes



These new 45V, 60V & 100V structured field-effect rectifier diodes enhance application performance and compactness

ST's new series ranging from 45V to 100V field-effect rectifier diodes (FERD) range from 20 to 40 A with 6 package options. Based on a proprietary process, these diodes achieve the best-in-class V_F/I_R trade-off for a given chip surface. These diodes exhibit much better intrinsic performance than traditional Schottky-structured diodes of equivalent voltage and current ratings. The combination of a lower V_F diode, with better control of leakage current, integrated into a smaller die enable designers to use smaller packages, resulting in a higher application compactness, with potential cost benefits.

KEY FEATURES

- Lower $V_F \times I_R$ than corresponding Schottky diode
- Smaller chip than Schottky for the same current rating
- Lower thermal coefficient
- Unique 30A device in DPAK
- ECOPACK2 components

KEY BENEFITS

- Improves application efficiency and thermal performance
- Wide selection of 26 devices
- Easier compact design at competitive prices
- Best performance reproducibility thanks to low V_F/I_R variations over current, voltage, and temperature ranges
- Higher reliability thanks to a lower leakage current

KEY APPLICATIONS

- Industrial power
 - Factory automation
 - Tooling chargers
- Auxiliary power
 - Server & telecom power
 - Air-conditioning
 - Home appliances
 - UPS
- DC/DC converters
- SMPS
- USB chargers

DESIGN SAFE, COMPACT, AND AFFORDABLE POWER SUPPLIES

ST's new 45V to 100V field-effect rectifier diodes (FERD) help power converter designers reach higher efficiency and increased density at levels that were not achievable using traditional Schottky solutions.

In regards to power density, our new FERD dice are much smaller than Schottky ones and can be easily integrated into smaller packages. For example, a 20A or higher

FERD diode housed in a DPAK package reduces by a factor of 3 the PCB surface occupied by a Schottky diode of the same current rating housed in a D²PAK package. Of course, the application's overall electrical performance is maintained and often improved using FERD diodes.

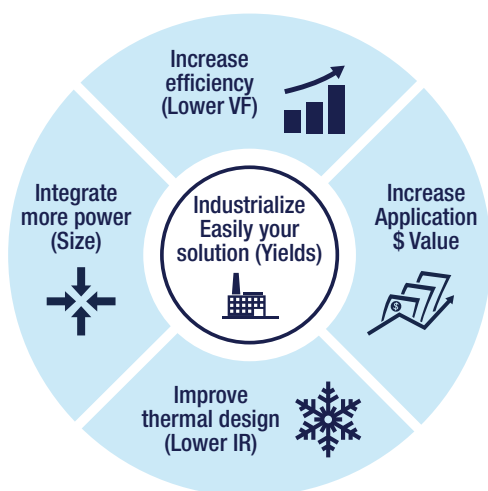
In addition to the power integration benefits, the potential positive economic impact of using a less expensive package solution

must be taken into account.

Moreover, ST's patented FERD technology exhibits a much better controlled leakage current, with a lower thermal coefficient than standard Schottky diodes.

Therefore, developers will appreciate an easier thermal design, with reduced thermal runaway risks, and the associated improved reliability.

KEY CHALLENGES FOR DIODES IN THE TARGETED MARKETS: THE 5x «I»s



The 5x «I»s Challenges

Need More Thermal margin with better efficiency, and more power in smaller form factor, to have increased application value, with enhanced tolerances to ensure industrial yields.

PRODUCT PORTFOLIO

Part Number	$I_{F(AV)}$ (A)	V_{RRM} (V)	V_F at I_F 125°C typ. / max. (V)	I_R at V_{RRM} 125°C max. (mA)	Packages
FERD2045S	20	45	0.520 / 0.570	40	DPAK
FERD20H60C	2 x 10	60	0.525 / 0.585	20	TO-220AB, D ² PAK
FERD20L60C	2 x 10	60	0.510 / 0.575	60	TO-220AB, D ² PAK
FERD20M60	20	60	0.510 / 0.560	20	TO-220AB, I ² PAK
FERD20U60DJFD	20	60	0.465 / 0.505	70	PowerFLAT™ (6 x 5 mm)
FERD30H60C	2 x 15	60	0.540 / 0.600	20	TO-220AB, D ² PAK
FERD30L60C	2 x 15	60	0.510 / 0.570	60	TO-220AB, D ² PAK
FERD40L60C	2 x 20	60	0.515 / 0.580	80	TO-220AB, D ² PAK
FERD20S100S	20	100	0.690 / 0.760	12	DPAK, IPAK, TO-220AB
FERD20H100S	20	100	0.640 / 0.705	16	DPAK, IPAK, TO-220AB, TO-220FPAB
FERD30H100S	30	100	0.680 / 0.745	16	DPAK, IPAK, TO-220AB
FERD30SM100DJF	30	100	0.665 / 0.735	16	PowerFLAT™ (6 x 5 mm)
FERD40H100S	40	100	0.645 / 0.705	24	D ² PAK, TO-220AB

